PD-95417

## International **ICR** Rectifier HEXFET<sup>®</sup> Power MOSFET

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free
- Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

	Parameter	Max.	Units	
ID @ Tc = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10 V 3.6			
ID @ Tc = 100°C	Continuous Drain Current, VGS @ 10 V	2.3	A	
IDM	Pulsed Drain Current ①	14		
Pp @ Tc = 25°C	Power Dissipation	74	W	
	Linear Derating Factor	0.59	W/°C	
VGS	Gate-to-Source Voltage	±20	V	
EAS	Single Pulse Avalanche Energy @	290	mJ	
IAR	Avalanche Current ①	3.6	A	
EAR	Repetitive Avalanche Energy ①	7.4	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	3.0	V/ns	
TJ TSTG	Operating Junction and Storage Temperature Range	-55 to +150	°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1 N•m)		

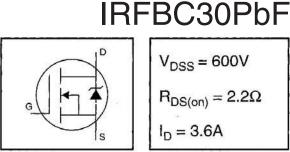
#### Absolute Maximum Ratings

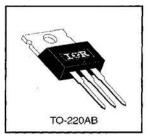
#### **Thermal Resistance**

	Parameter	Min.	Тур.	Max.	Units	
Rejc	Junction-to-Case		—	1.7	°C/W	
Recs	Case-to-Sink, Flat, Greased Surface	_	0.50			
Reja	Junction-to-Ambient	-		62	7	

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 $V_{DSS} = 600V$ 

 $R_{DS(on)} = 2.2\Omega$ 

 $I_{\rm D} = 3.6 {\rm A}$ 

	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
V(BR)DSS	Drain-to-Source Breakdown Voltage	600	-	-	V	V <sub>GS</sub> =0V, I <sub>D</sub> = 250µA	
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	1. (i <del></del>	0.62		V/ºC	Reference to 25°C, ID= 1mA	
RDS(on)	Static Drain-to-Source On-Resistance	2	—	2.2	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =2.2A ④	
VGS(th)	Gate Threshold Voltage	2.0	—	4.0	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = 250μA	
<b>g</b> <sub>fs</sub>	Forward Transconductance	2.5		-	S	V <sub>DS</sub> =100V, I <sub>D</sub> =2.2A ④	
loss	Drain-to-Source Leakage Current		-	100	μA	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V	
		-	-	500		V <sub>DS</sub> =480V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C	
lass	Gate-to-Source Forward Leakage		—	100	пA	V <sub>GS</sub> =20V	
IGSS	Gate-to-Source Reverse Leakage	-	—	-100	ПА	V <sub>GS</sub> =-20V	
Qg	Total Gate Charge	-	—	31		ID=3.6A	
Qgs	Gate-to-Source Charge	-	-	4.6	nC	V <sub>DS</sub> =360V	
Qgd	Gate-to-Drain ("Miller") Charge	-	—	17		V <sub>GS</sub> =10V See Fig. 6 and 13 ④	
t <sub>d(on)</sub>	Turn-On Delay Time		11	-		V <sub>DD</sub> =300V	
tr	Rise Time		13	$\rightarrow$	ns	ID=3.6A	
t <sub>d(off)</sub>	Turn-Off Delay Time	-	35		115	R <sub>G</sub> =12Ω	
tı	Fall Time		14			R <sub>D</sub> =82Ω See Figure 10 ⊕	
LD	Internal Drain Inductance	=	4.5	1	اللع	Between lead, 6 mm (0.25in.)	
Ls	Internal Source Inductance	-	7.5	1	nH	from package and center of die contact	
Ciss	Input Capacitance	-	660	_		V <sub>GS</sub> =0V	
Coss	Output Capacitance	-	86	<u> </u>	pF	V <sub>DS</sub> =25V	
Crss	Reverse Transfer Capacitance		19		4 645H H	f=1.0MHz See Figure 5	

### Electrical Characteristics @ TJ = 25°C (unless otherwise specified)

### Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Test Conditions
ls	Continuous Source Current (Body Diode)		-	3.6	A	MOSFET symbol showing the integral reverse p-n junction diode.
Ism	Pulsed Source Current (Body Diode) ①	-	-	14		
V <sub>SD</sub>	Diode Forward Voltage	_		1.6	V	TJ=25°C, IS=3.6A, VGS=0V @
t <sub>rr</sub>	Reverse Recovery Time		370	810	ns	Tj=25°C, IF=3.6A
Qrr	Reverse Recovery Charge		2.0	4.2	μC	di/dt=100A/µs ④
t <sub>on</sub>	Forward Turn-On Time	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+Lp)				

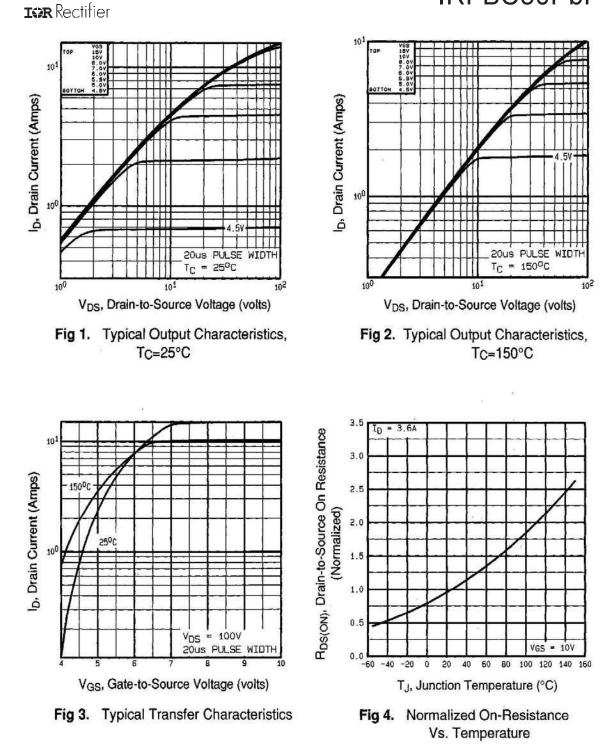
#### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)
- ② V<sub>DD</sub>=50V, starting T<sub>J</sub>=25°C, L=41mH R<sub>G</sub>=25Ω, I<sub>AS</sub>=3.6A (See Figure 12)

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③ IsD≤3.6A, di/dt≤60A/µs, VDD≤V(BR)DSS, TJ≤150°C

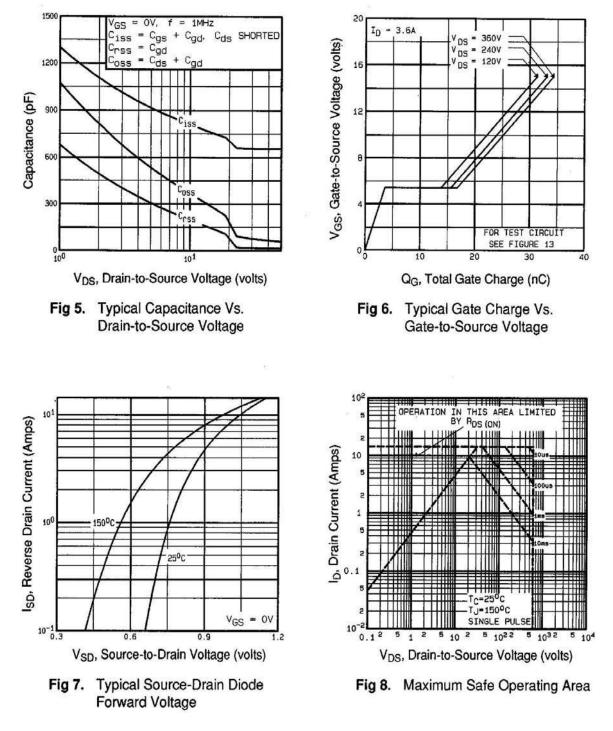
④ Pulse width  $\leq$  300 µs; duty cycle  $\leq$ 2%.



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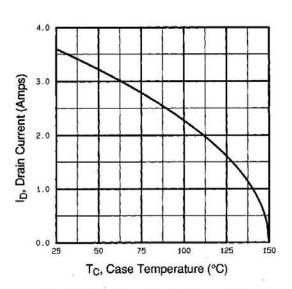
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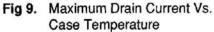


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# IRFBC30PbF





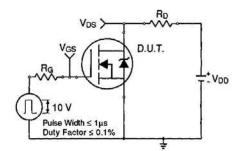


Fig 10a. Switching Time Test Circuit

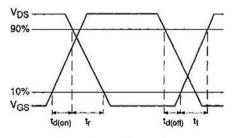
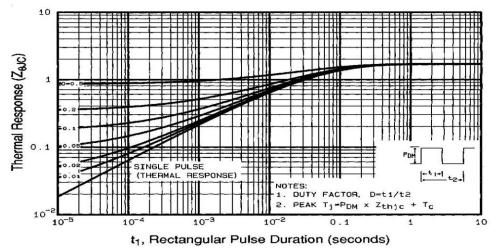


Fig 10b. Switching Time Waveforms





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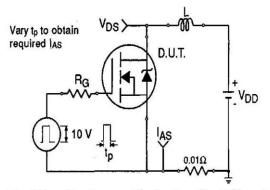


Fig 12a. Unclamped Inductive Test Circuit

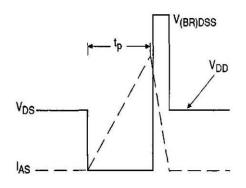
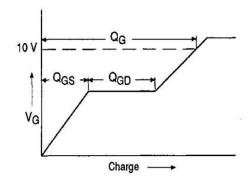
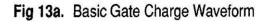
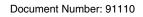
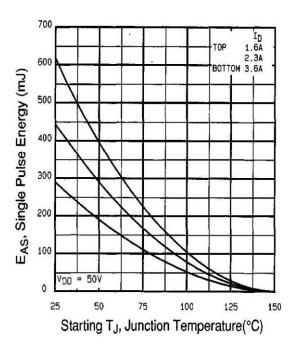


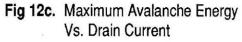
Fig 12b. Unclamped Inductive Waveforms











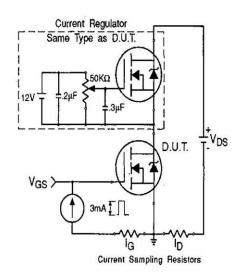
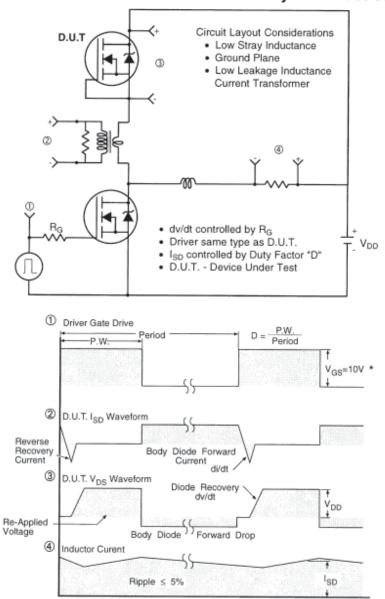


Fig 13b. Gate Charge Test Circuit

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### Peak Diode Recovery dv/dt Test Circuit

\* V<sub>GS</sub> = 5V for Logic Level Devices

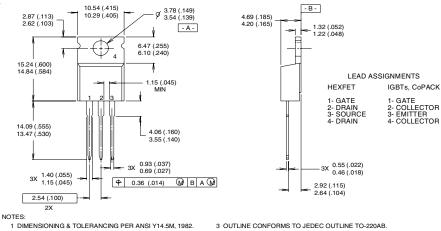


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## TO-220AB Package Outline

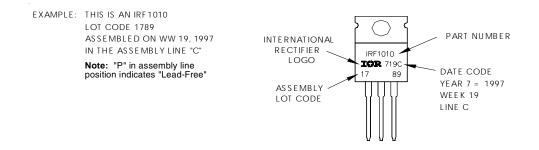
Dimensions are shown in millimeters (inches)



2 CONTROLLING DIMENSION : INCH

3 OUTLINE CONFORMS TO JEDEC OUTLINE TO-220AB.4 HEATSINK & LEAD MEASUREMENTS DO NOT INCLUDE BURRS.

### **TO-220AB Part Marking Information**



Data and specifications subject to change without notice.

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